



Energizing Superconductors

Cost-effective production of HTS wires by chemical solution deposition

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Grids

CSD processing



- Chemical solution deposition for complete layer architecture
 - Best price performance ratio for large volume production
 - Unique and protected technology







Content



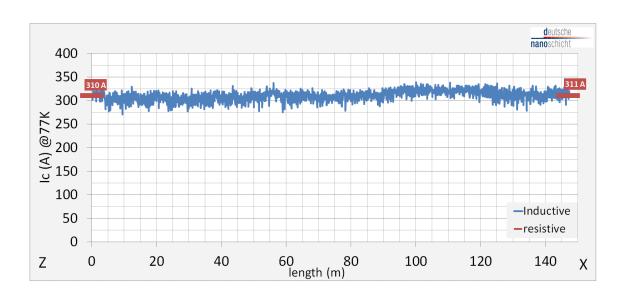
- Industrial applications
 - DC bus bars
 - Long length laminates
 - Performance at low fields and high temperatures
 - Production upscaling
 - Magnets
 - Performance at medium fields and low temperatures
 - Joint technology
 - Mechanical performance: bending
- Distribution grids
 - AC cables
 - Non-magnetic substrates
 - Mechanical requirements: strain and twist



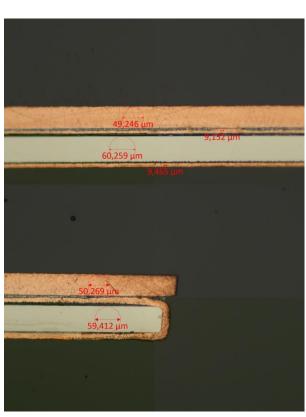
Industrial applications **DC bus bars**



- single copper laminate HTS neutral fiber
 - Long length with high homogeneity
 - Mechanical and electrical stability with high J_e



150m x 10mm, 310±10A (@77K,sf), homogeneity <5%



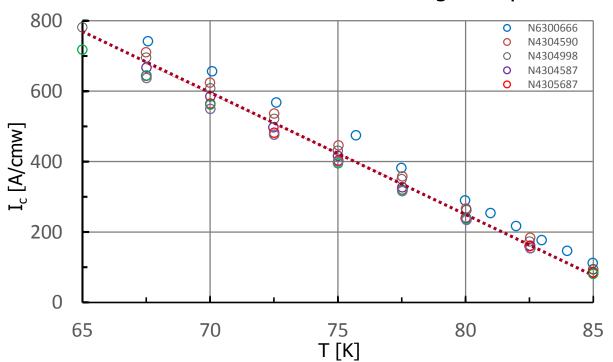
50µm single copper laminate



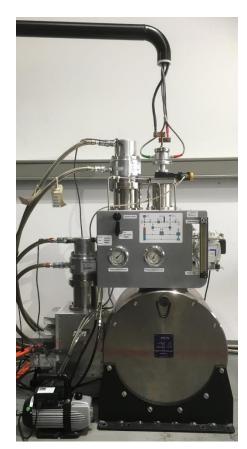
Industrial applications **DC bus bars**



- single copper laminate HTS neutral fiber
 - Performance at low fields and high temperatures



Best HTS tapes > 800A @65K,sf



I_c (B,°,T) system (0-5T, 0-180°, 0-800A, 20-100K)



Industrial applications **DC bus bars**



- single copper laminate HTS neutral fiber
 - Upscaling: wide tapes and production devices



4x25m high temperature annealing furnace



40mm fully buffered tape

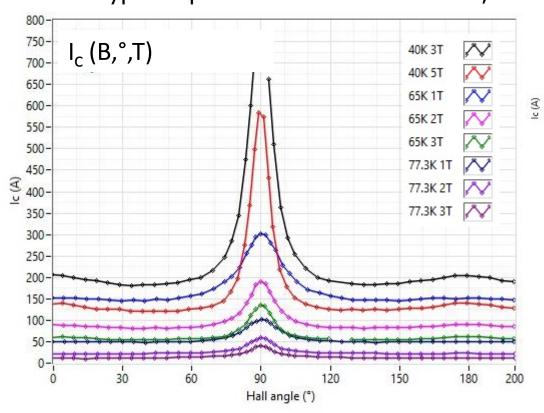


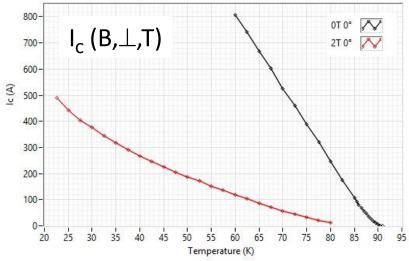
Industrial applications

Magnets



- Performance at low temperatures and medium magnetic fields
 - Typical operation conditions: 30-50K, 1-3T





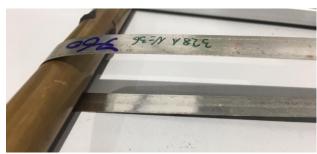
Typical $I_c(B,T)$ behaviour

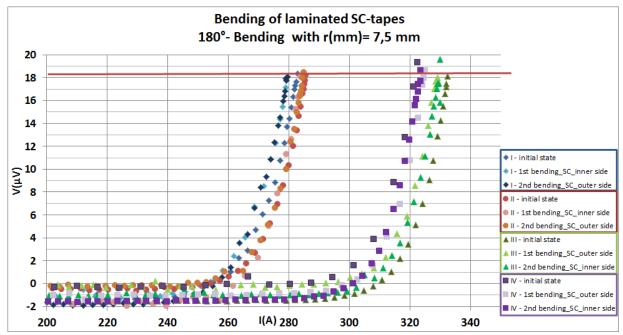


Industrial applications **Magnets**



- Customized laminates
 - Small bending diameter possible



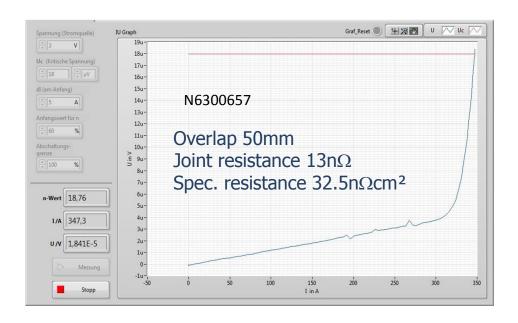


I_c degradation < 2% for double bending on 15mm diameter



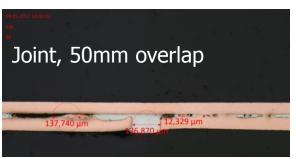
Industrial applications **Magnets**

- Joints and splices
 - Bridge-type joints
 - Lead free solder paste (mp >200°C)



Typical joint resistance <**20**n Ω







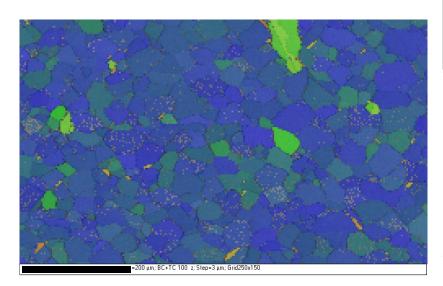
Device for joints and splices



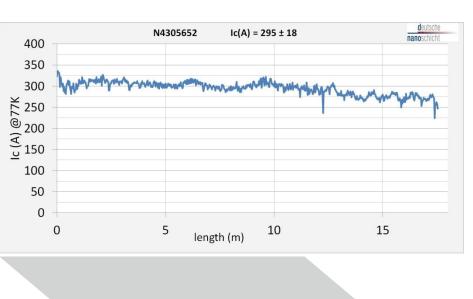
Grid applications **AC cables**

deutsche nanoschicht

- Non-magnetic substrates
 - <100m processing in R&D</p>
 - I_c (@Ni9W) $\approx I_c$ (@Ni5W)



EBSD: 93,4% index rate, 94% in 10° tilt







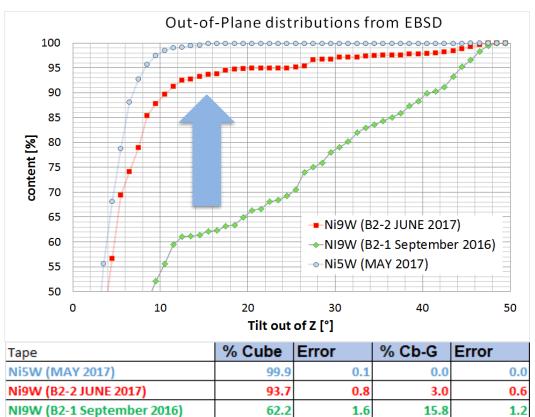
Grid applications **AC cables**



- Non-magnetic substrates
 - Improvements in large scale processing



~10 t ingot processed to 60 µ tape



Preference in cube growth >90%



Grid applications **AC cables**



Mechanical requirements

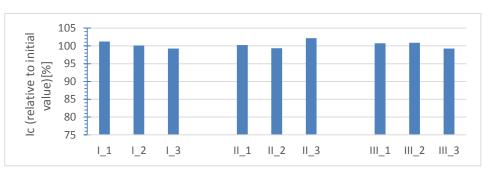
Tensile stress: 250mPa

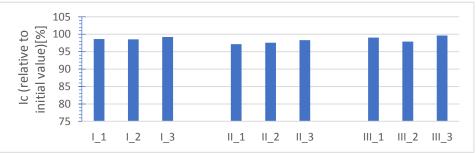
Twist: 200mm, 360°

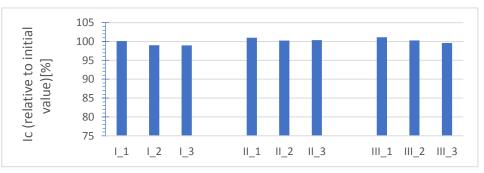
Bending: Ø 30mm

3 batches of 10mm wide HTS tape

HTS tapes fullfill typical requirements for AC cable applications







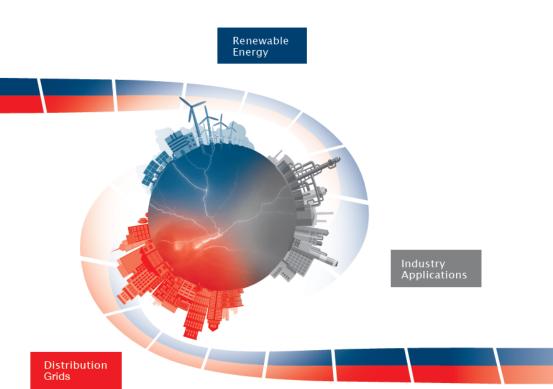


Summary



- Up-scaling of production ongoing
 - 40mm technology partially implemented
- HTS tapes customized for applications available
 - Laminates, joints
- Mechanical and electrical specifications reached
 - Bending, twist, strain, resistance, I_c (B,°,T)
- In-house test facilities qualified
 - 5T-I_c-tester, mechanical testing







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Thanks for your attention

